

March 1994 Revised November 1999

74ABT16374 16-Bit D-Type Flip-Flop with 3-STATE Outputs

General Description

The ABT16374 contains sixteen non-inverting D-type flipflops with 3-STATE outputs and is intended for bus oriented applications. The device is byte controlled. A buffered clock (CP) and Output Enable $\overline{(\text{OE})}$ are common to each byte and can be shorted together for full 16-bit operation.

Features

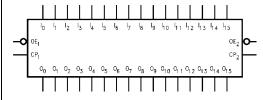
- Separate control logic for each byte
- 16-bit version of the ABT374
- Edge-triggered D-type inputs
- Buffered Positive edge-triggered clock
- High impedance glitch free bus loading during entire power up and power down cycle
- Non-destructive hot insertion capability
- Guaranteed latch-up protection

Ordering Code:

Order Number	Package Number	Package Description				
74ABT16374CSSC	MS48A	48-Lead Small Shrink Outline Package (SSOP), JEDEC MO-118, 0.300" Wide				
74ABT16374CMTD	MTD48	48-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide				

Devices also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering code.

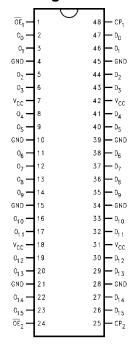
Logic Symbol



Pin Descriptions

Pin Name	Description				
OE _n 3-STATE Output Enable Input (Active LO					
CP _n	Clock Pulse Input (Active Rising Edge)				
D ₀ -D ₁₅	Data Inputs				
O ₀ -O ₁₅	3-STATE Outputs				

Connection Diagram



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DS011668

Functional Description

The ABT16374 consists of sixteen edge-triggered flip-flops with individual D-type inputs and 3-STATE true outputs. The device is byte controlled with each byte functioning identically, but independent of the other. The control pins can be shorted together to obtain full 16-bit operation. Each byte has a buffered clock and buffered Output Enable common to all flip-flops within that byte. The description which follows applies to each byte. Each flip-flop will store the state of their individual D inputs that meet the setup and hold time requirements on the LOW-to-HIGH Clock (CPn) transition. With the Output Enable (\overline{OE}_n) LOW, the contents of the flip-flops are available at the outputs. When $\overline{\text{OE}}_n$ is HIGH, the outputs go to the high impedance state. Operation of the OE_n input does not affect the state of the flip-flops.

Truth Tables

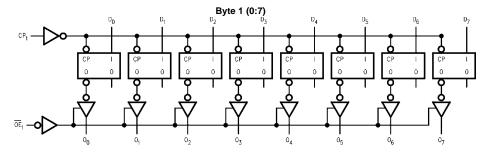
	Inputs		Outputs
CP ₁	OE ₁	D ₀ -D ₇	O ₀ -O ₇
~	L	Н	Н
~	L	L	L
L	L	Х	(Previous)
Х	Н	Х	Z

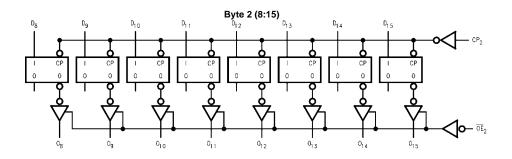
		Inputs	Outputs	
	CP ₂	O ₈ -O ₁₅		
Ī	~	L	Н	Н
	~	L	L	L
	L	L	Χ	(Previous)
	X	Н	Х	Z

H = HIGH Voltage Level

- L = LOW Voltage Level
- X = Immaterial Z = High Impedance

Logic Diagrams





Absolute Maximum Ratings(Note 1)

Recommended Operating Conditions

Storage Temperature -65°C to +150°C

Free Air Ambient Temperature -40°C to +85°C -55°C to +125°C Ambient Temperature under Bias -55°C to +150°C Supply Voltage +4.5V to +5.5V Junction Temperature under Bias

-0.5V to +7.0V Minimum Input Edge Rate ($\Delta V/\Delta t$) V_{CC} Pin Potential to Ground Pin

Data Input 50 mV/ns Input Voltage (Note 2) -0.5V to +7.0V**Enable Input** 20 mV/ns Input Current (Note 2) -30 mA to +5.0 mA Voltage Applied to Any Output Clock Input 100mV/ns

in the Disabled or

Power-Off State -0.5V to 5.5V in the HIGH State -0.5V to $V_{\mbox{\footnotesize CC}}$

Current Applied to Output

in LOW State (Max) twice the rated I_{OL} (mA)

DC Latchup Source Current:

OE Pin -350 mA

Note 1: Absolute maximum ratings are values beyond which the device (Across Comm Operating Range) may be damaged or have its useful life impaired. Functional operation $-500\;\text{mA}$ under these conditions is not implied.

Other Pins

10V Note 2: Either voltage limit or current limit is sufficient to protect inputs. Over Voltage Latchup (I/O)

DC Electrical Characteristics

Symbol	Param	eter	Min	Тур	Max	Units	v _{cc}	Conditions
V _{IH}	Input HIGH Voltage		2.0			V		Recognized HIGH Signal
V_{IL}	Input LOW Voltage				0.8	V		Recognized LOW Signal
V_{CD}	Input Clamp Diode Vo	ltage			-1.2	V	Min	I _{IN} = -18 mA
V _{OH}	Output HIGH Voltage		2.5			V	Min	$I_{OH} = -3 \text{ mA}$
			2.0			V	Min	I _{OH} = -32 mA
V_{OL}	Output LOW Voltage				0.55	V	Min	I _{OL} = 64 mA
I _{IH}	Input HIGH Current				1	μА	Max	V _{IN} = 2.7V (Note 3)
					1	μА	IVIAX	$V_{IN} = V_{CC}$
I _{BVI}	Input HIGH Current B	reakdown Test			7	μΑ	Max	V _{IN} = 7.0V
I _{IL}	Input LOW Current				-1	μА	Max	V _{IN} = 0.5V (Note 3)
					-1	μА	IVIAX	$V_{IN} = 0.0V$
V_{ID}	Input Leakage Test		4.75			V	0.0	$I_{ID} = 1.9 \mu A$
								All Other Pins Grounded
I _{OZH}	Output Leakage Curre	ent			10	μΑ	0-5.5V	V _{OUT} = 2.7V; OE = 2.0V
I _{OZL}	Output Leakage Curre	ent			-10	μΑ	0-5.5V	V _{OUT} = 0.5V; OE = 2.0V
Ios	Output Short-Circuit C	Current	-100		-275	mA	Max	V _{OUT} = 0.0V
I _{CEX}	Output HIGH Leakage	e Current			50	μΑ	Max	V _{OUT} = V _{CC}
I_{ZZ}	Bus Drainage Test				100	μΑ	0.0	V _{OUT} = 5.5V; All Others V _{CC} or GND
I _{CCH}	Power Supply Current	t			2.0	mA	Max	All Outputs HIGH
I _{CCL}	Power Supply Current	t			62	mA	Max	All Outputs LOW
I _{CCZ}	Power Supply Current	t			2.0	mA	Max	$\overline{OE} = V_{CC}$; All Others at V_{CC} or GND
I _{CCT}	Additional I _{CC} /Input	Outputs Enabled			2.5	mA		$V_I = V_{CC} - 2.1V$
		Outputs 3-STATE			2.5	mA	Max	Enable Input V _I = V _{CC} - 2.1V
		Outputs 3-STATE			2.5	mA		Data Input V _I = V _{CC} - 2.1V
								All Others at V _{CC} or GND
I _{CCD}	Dynamic I _{CC}	No Load				mA/		Outputs Open
	(Note 3)				0.30	MHz	Max	OE = GND, (Note 4)
								One Bit Toggling, 50% Duty Cycle

Note 3: Guaranteed, but not tested.

Note 4: For 8-bit toggling, $I_{CCD} < 0.8 \text{ mA/MHz}.$

AC Electrical Characteristics

(SSOP Package)

Symbol	Parameter		$T_A = +25^{\circ}C$ $V_{CC} = +5.0V$ $C_L = 50 \text{ pF}$			$T_A = -40^{\circ}$ C to +85°C $V_{CC} = 4.5$ V to 5.5V $C_L = 50$ pF		
		Min	Тур	Max	Min	Max		
f _{MAX}	Maximum Clock Frequency	150			150		MHz	
t _{PLH}	Propagation Delay	1.8		6.2	1.8	6.2	20	
t _{PHL}	CP to O _n	1.8		5.9	1.8	5.9	ns	
t _{PZH}	Output Enable Time	1.2		5.6	1.2	5.6	no	
t _{PZL}		1.6		5.3	1.6	5.3	ns	
t _{PHZ}	Output Disable Time	2.2		7.1	2.2	7.1		
t _{PLZ}		2.2		6.6	2.2	6.6	ns	

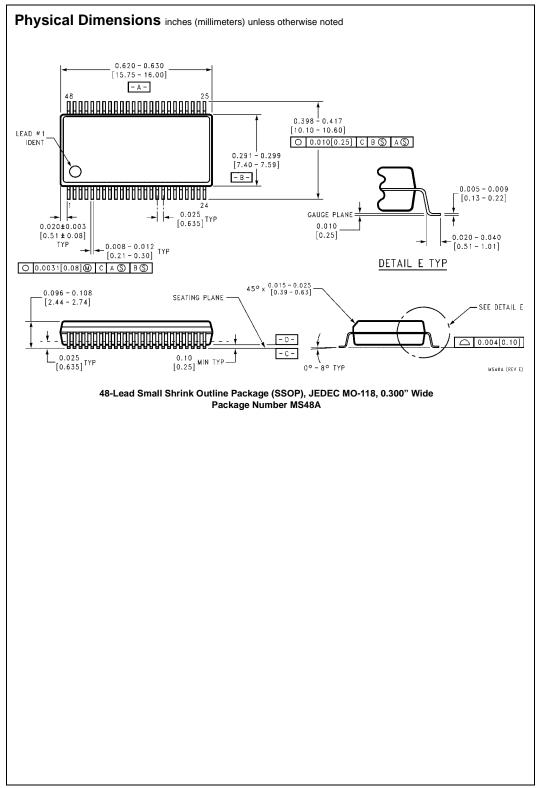
AC Operating Requirements

Symbol	Parameter	V _{CC} =	$T_A = +25^{\circ}C$ $V_{CC} = +5.0V$ $C_L = 50 \text{ pF}$		$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ $V_{CC} = 4.5\text{V to } 5.5\text{V}$ $C_L = 50 \text{ pF}$		
		Min	Max	Min	Max		
t _S (H)	Setup Time, HIGH	1.1		1.1			
t _S (L)	or LOW D _n to CP	1.1		1.1		ns	
t _H (H)	Hold Time, HIGH	1.3		1.3			
t _H (L)	or LOW D _n to CP	1.3		1.3		ns	
t _W (H)	Pulse Width, CP	3.0		3.0		ns	
$t_W(L)$	HIGH or LOW	3.0		3.0			

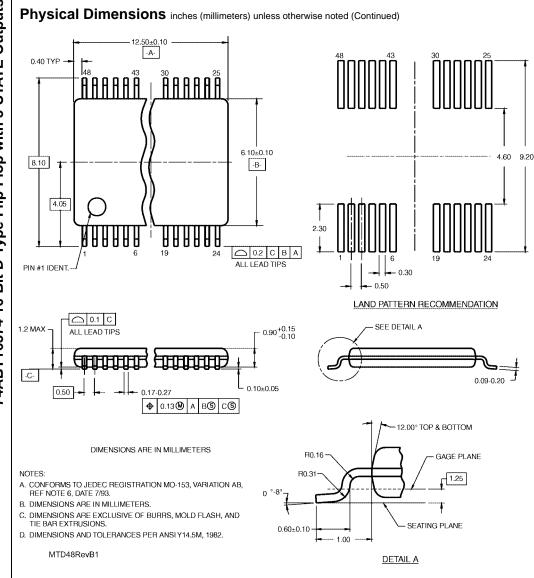
Capacitance

Symbol	Parameter	Тур	Units	Conditions (T _A = 25°C)
C _{IN}	Input Capacitance	5.0	pF	$V_{CC} = 0V$
C _{OUT} (Note 5)	Output Capacitance	11.0	pF	V _{CC} = 5.0V

Note 5: C_{OUT} is measured at frequency f = 1 MHz, per MIL-STD-883, Method 3012.







48-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide Package Number MTD48

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